

Tego Chemie formulation No. 3001

08/07

FUNCTION	PRODUCT	PRODUCER	PBW
Silicone epoxy resin	SILIKOPON EW	Tego Chemie	26.30
Spinel black	HEUCODUR®-Schwarz 9-100	Heubach	8.00
Carbon black	Printex L	Degussa, today Evonik	1.20
Magnesium aluminium silicate	Plastorit 0000	Luzenac	9.20
Anticorrosive pigment	HEUCOPHOS® ZPO	Heubach	5.00
Magnesium silicate	Micro-Talc A.T. Extra	Mondo Minerals	5.10
Solvent	Solvesso 100	Exxon	13.00
Rheology modifier	Bentone SD-2	Elementis	0.20
Solvent	Methoxypropyl acetate		4.50
Grind.			
Silicone epoxy resin	SILIKOPON EW	Tego Chemie	15.80
Solvent	Butyl acetate		4.60
Aromatic hydrocarbon	Xylene		7.10
Add while mixing.			
			100.00

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